

02-28-2001

ASSIGNMENT



101623270

EET

To: Honorable Commissioner of Patents and Trademarks:

2. 15-01

Please record the attached original document(s) or copy thereof.

1. Name of conveying party(ies)

a) VLSI Technology, Inc.

2. Name and address of receiving party(ies):

a) Name: Philips Semiconductors Inc.
Address: 1000 West Maude Avenue
Sunnyvale, CA 94085-2810

3. Nature of conveyance

☐

Assignment

☐

Security Agreement

☐

Other _____

☐

Merger

☒

Change of Name

☐

License Agreement

Execution Date: July 2, 1999 and December 29, 1999

4. Application Number(s) or Patent Number(s): See Appendix A

The title of the (new) application is:

See Appendix A

09392343

5. Please send all correspondence concerning this (these) documents to:

OPPENHEIMER WOLFF & DONNELLY LLP
P.O. Box 52037
Palo Alto, CA 94303-0746
Tel. No.: (650) 470-7430
Fax No.: (650) 470-7440

6. Total number of applications and patents involved: 10

7. Total fee (37 CFR 3.41): \$400.00

☒

Enclosed

☐

Authorized to be charged to Deposit Account No. 02-3964
(Order No. VTI1G000)

8. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Date: February 8, 2001

Robert D. Hayden
Registration No. 42,645

02/27/2001 6TOW11 00000163 09392343

01 FC:581

400.00 DP

Attorney Docket No. VTI1G000

(Revised 01/96)

PATENT
REEL: 011532 FRAME: 0923

APPENDIX A

ATTY. DKT. NO.	TITLE	SERIAL NO.	FILING DATE
VT11P157B	TUNGSTEN PLUGS FOR INTEGRATED CIRCUITS AND METHODS FOR MAKING SAME	09/392,343	September 8, 1999
VT11P201	PROCESS TO IMPROVE ADHESION OF PECVD CAP LAYERS IN INTEGRATED CIRCUITS	09/121,180	July 22, 1998
VT11P207	A SYSTEM AND METHOD FOR PHOTORESIST SHAVING	09/243,651	February 1, 1999
VT11P212	SYSTEM AND METHOD FOR CROSS STREAM REGASSIFIER FOR IMPROVED CHEMICAL POLISHING IN THE MANUFACTURE OF SEMICONDUCTORS	09/299,707	April 26, 1999
VT11P213	ELECTRICALLY PLANAR UPPER ELECTRODE COVER	09/304,142	May 3, 1999
VT11P214	SYSTEM AND METHOD FOR PREVENTING ELECTROCHEMICAL EROSION BY DEPOSITING A PROTECTIVE FILM	09/287,320	April 7, 1999
VT11P215	SEMICONDUCTOR BLOCKING LAYER FOR PREVENTING UV RADIATION DAMAGE TO RO MOS GATE OXIDES	09/315,596	May 20, 1999
VT11P216	METHOD AND APPARATUS FOR PRODUCING CLEAN INTEGRATED CIRCUIT BONDING PADS	09/299,685	April 26, 1999
VT11P217	A SYSTEM AND METHOD FOR RESIDUE ENTRAPMENT UTILIZING A POLISH AND SACRIFICIAL FILL FOR SEMICONDUCTOR FABRICATION	09/262,439	March 4, 1999
VT11P218	METHOD AND APPARATUS FOR CLEANING INTEGRATED CIRCUIT BONDING PADS	09/299,682	April 26, 1999

ATTY DKT. NO.: VT11G000

State of Delaware
Office of the Secretary of State PAGE 1

I, EDWARD J. FREEL, SECRETARY OF STATE OF THE STATE OF DELAWARE, DO HEREBY CERTIFY THE ATTACHED IS A TRUE AND CORRECT COPY OF THE CERTIFICATE OF AMENDMENT OF "VLSI TECHNOLOGY, INC.", CHANGING ITS NAME FROM "VLSI TECHNOLOGY, INC." TO "PHILIPS SEMICONDUCTORS VLSI INC.", FILED IN THIS OFFICE ON THE SECOND DAY OF JULY, A.D. 1999, AT 9 O'CLOCK A.M.

A FILED COPY OF THIS CERTIFICATE HAS BEEN FORWARDED TO THE NEW CASTLE COUNTY RECORDER OF DEEDS.



Edward J. Freel, Secretary of State

2125539 8100

AUTHENTICATION: 9846969

DATE: 07 02 99

001772477

PATENT
REEL: 011532 FRAME: 0925

SECRETARY'S CERTIFICATE

I, W. T. OATES, JR., Secretary of Philips Semiconductors Inc., do hereby certify:

1. that attached is a true and correct copy of Certificate of Amendment of Certificate of Incorporation as filed with the Secretary of State of the State of Delaware on July 2, 1999 changing the name of VLSI Technology, Inc. to Philips Semiconductors VLSI Inc.
2. that attached is a true and correct copy of Certificate of Merger merging Philips Semiconductors Inc. into Philips Semiconductors VLSI Inc. and change of name of survivor Philips Semiconductors VLSI Inc. to Philips Semiconductors Inc. as filed with the Secretary of State of the State of Delaware on December 29, 1999.

IN WITNESS WHEREOF, I have hereto set my hand and affixed the Corporate Seal

on May 17, 2000.


Secretary

STATE OF DELAWARE
SECRETARY OF STATE
DIVISION OF CORPORATIONS
FILED 09:00 AM 07/02/1999
991273471 - 2125539

CERTIFICATE OF AMENDMENT
OF
CERTIFICATE OF INCORPORATION

VLSI Technology, Inc., a corporation organized and existing under and by virtue of the General Corporation Law of the State of Delaware, DOES HEREBY CERTIFY:

FIRST: That the Board of Directors of VLSI Technology, Inc., by unanimous written consent of its members, filed with the minutes of the board, duly adopted resolutions setting forth a proposed amendment to the Certificate of Incorporation of said corporation, declaring said amendment to be advisable:

RESOLVED, that the Certificate of Incorporation of this Corporation be amended by changing the first Article thereof so that, as amended, said Article shall be and read as follows:

FIRST. The name of the Corporation is PHILIPS SEMICONDUCTORS VLSI INC."

SECOND: That in lieu of a meeting and vote of stockholders, the stockholders have given unanimous written consent to said amendment in accordance with the provisions of Section 228 of the General Corporation of the State of Delaware.

THIRD: That the aforesaid amendment was duly adopted in accordance with the applicable provisions of Section 242 and 228 of the General Corporation Law of the State of Delaware.

IN WITNESS WHEREOF, said VLSI Technology, Inc. has caused this certificate to be signed by Paul S. Friedlander, its Vice President and attested by Warren T. Oates, Jr., its Assistant Secretary this 2nd day of July, 1999.

VLSI TECHNOLOGY, INC.

By. 

Vice President


ATTEST:


Assistant Secretary

SECRETARY'S CERTIFICATE

I, W. T. OATES, JR., Secretary of Philips Semiconductors Inc., do hereby certify that the attached is a true and correct copy of Certificate of Merger merging Philips Semiconductors Inc. into Philips Semiconductors VLSI Inc. and change of name of survivor Philips Semiconductors VLSI Inc. to Philips Semiconductors Inc. as filed with the Secretary of State of the State of Delaware on December 29, 1999.

IN WITNESS WHEREOF, I have hereunto set my hand and affixed the Corporate Seal
on May 16, 2000.


Secretary

State of Delaware
Office of the Secretary of State

PAGE 1

I, EDWARD J. FREEL, SECRETARY OF STATE OF THE STATE OF DELAWARE, DO HEREBY CERTIFY THE ATTACHED IS A TRUE AND CORRECT COPY OF THE CERTIFICATE OF MERGER, WHICH MERGES:

"PHILIPS SEMICONDUCTORS INC.", A DELAWARE CORPORATION,
WITH AND INTO "PHILIPS SEMICONDUCTORS VLSI INC." UNDER THE NAME OF "PHILIPS SEMICONDUCTORS INC.", A CORPORATION ORGANIZED AND EXISTING UNDER THE LAWS OF THE STATE OF DELAWARE, AS RECEIVED AND FILED IN THIS OFFICE THE TWENTY-NINTH DAY OF DECEMBER, A.D. 1999, AT 9 O'CLOCK A.M.

AND I DO HEREBY FURTHER CERTIFY THAT THE EFFECTIVE DATE OF THE AFORESAID CERTIFICATE OF MERGER IS THE FIRST DAY OF JANUARY, A.D. 2000.

A FILED COPY OF THIS CERTIFICATE HAS BEEN FORWARDED TO THE NEW CASTLE COUNTY RECORDER OF DEEDS.



Edward J. Freel
Edward J. Freel, Secretary of State

AUTHENTICATION:

0172467

DATE:

12-30-99

2125539 8100M

991566771

PATENT
REEL: 011532 FRAME: 0929

STATE OF DELAWARE
SECRETARY OF STATE
DIVISION OF CORPORATIONS
FILED 09:00 AM 12/29/1999
991566771 2125539

CERTIFICATE OF MERGER**OF****PHILIPS SEMICONDUCTORS INC.****AND****PHILIPS SEMICONDUCTORS VLSI INC.**

It is hereby certified that:

1. The constituent business corporations participating in the merger herein certified are:

Philips Semiconductors Inc., which is incorporated under the laws of the State of Delaware; and

Philips Semiconductors VLSI Inc., which is incorporated under the laws of the State of Delaware.

2. An Agreement of Merger has been approved, adopted, certified, executed, and acknowledged by each of the aforesaid constituent corporations in accordance with the provisions of subsection (c) of Section 251 of the General Corporation Law of the State of Delaware.

3. The name of the surviving corporation in the merger herein certified is Philips Semiconductors VLSI Inc., which will continue its existence as said surviving corporation under the name Philips Semiconductors Inc. upon the effective date of said merger pursuant to the provisions of the General Corporation Law of the State of Delaware.

4. The Certificate of Incorporation of Philips Semiconductors VLSI Inc. is to be amended and changed by reason of the merger herein certified by striking out Article FIRST, relating to the name, by substituting in lieu thereof the following article:

"FIRST: The name of the Corporation is PHILIPS SEMICONDUCTORS INC."

and said Certificate of Incorporation as so amended and changed shall continue to be the Certificate of Incorporation of said surviving corporation until further amended and changed in accordance with the provisions of the General Corporation Law of the State of Delaware.

5. The executed Agreement of Merger between the aforesaid constituent corporations is on file at an office of the aforesaid surviving corporation, the address of which is as follows: 1251 Avenue of the Americas, New York, NY 10020


6. A copy of the aforesaid Agreement of Merger will be furnished by the aforesaid surviving corporation, on request, and without cost, to any stockholder of each of the aforesaid constituent corporations.

7. The Agreement of Merger between the aforesaid constituent corporations provides that the merger herein certified shall be effective at 12:02 a.m. January 1, 2000 Pacific Standard Time.

Dated: December 20, 1999

PHILIPS SEMICONDUCTORS INC.

By:



(Name, Title) Belinda W. Chew, Vice President

Dated: December 20, 1999

PHILIPS SEMICONDUCTORS VLSI INC.

By:



(Name, Title) Warren T. Oates, Jr., Vice President